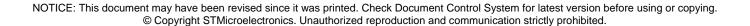
DOCUMENT HISTORY

Version	Release Date	Change Qualifier		
Rev 6.1		Document change		
07/01/2014 AUTOMATIC REVALIDATION DATE WORKFLOW STARTED				



DOCUMENT APPROVAL

LABEL	USER FUNCTION	DATE
Donohoo Sean Michael	Document Controller	17-Apr-2015





STPS41L60C

Power Schottky rectifier

Features

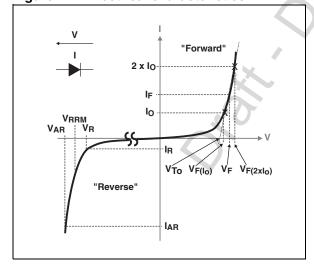
- Low forward voltage drop
- Negligible switching losses
- Low thermal resistance
- Avalanche capability specified

Description

These dual center tap Schottky rectifiers are suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in D²PAK, I²PAK and TO-220AB, this device is intended for use in low voltage, high frequency inverters, free-wheeling and polarity protection applications.

Figure 1. Electrical characteristics (a)



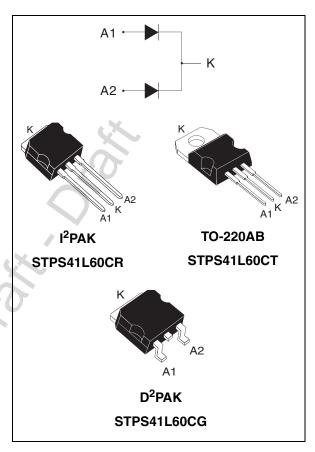


Table 1. Device summary

I _{F(AV)}	2 x 20 A
V _{RRM}	60 V
T _{j (max)}	150 °C
V _{F (max)}	0.58 V

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V_{ARM} and I_{ARM} must respect the reverse safe operating area defined in *Figure 12* V_{AR} and I_{AR} are pulse measurements (t_p < 1 μs). V_R, I_R, V_{RRM} and V_F, are static characteristics

1 **Characteristics**

Table 2. Absolute ratings (limiting values, per diode)

Symbol	Parameter	Value	Unit		
V _{RRM}	Repetitive peak reverse voltage	Repetitive peak reverse voltage			V
I _{F(RMS)}	Forward rms current			30	Α
I _{F(AV)}	Average forward current		20 40	Α	
I _{FSM}	Surge non repetitive forward current	tp = 10 ms Sin	usoidal	220	Α
P _{ARM} ⁽¹⁾	Repetitive peak avalanche power	$tp = 1 \mu s T_j = 2$	5 °C	9500	W
V _{ARM} ⁽²⁾	Maximum repetitive peak avalanche voltage	$t_p < 1 \ \mu s, \ T_j < 1$	50 °C, I _{AR} < 35 A	80	V
V _{ASM} (2)	Maximum single pulse peak avalanche voltage	$t_p < 1 \ \mu s, \ T_j < 1$	50 °C, I _{AR} < 35 A	80	V
T _{stg}	Storage temperature range		.0	-65 to + 175	°C
Tj	Maximum operating junction temperature ⁽³⁾			150	°C

For temperature or pulse time duration deratings, refer to *Figure 4* and *Figure 5*. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the application notes AN1768 and AN2025.

Table 3. Thermal resistances

Symbol	Parameter Valu			Value	Unit
R _{th (j-c)}	Junction to case		Per diode Total	1.5 0.8	° C/W
R _{th (c)}	Coupling			0.1	

When the diodes 1 and 2 are used simultaneously: $\Delta T_j(diode 1) = P(diode 1) \times R_{th(j-c)}(Per diode) + P(diode 2) \times R_{th(c)}$

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
{I} (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V- - V			600	μΑ
'R`		T _j = 125 °C	$V_R = V_{RRM}$		100	175	mA
	(1) Formula welltone along	T _j = 25 °C	I _F = 20 A			0.60	
V _F ⁽¹⁾		T _j = 125 °C	I _F = 20 A		0.50	0.58	V
V _F ⁽¹⁾ Forward voltage drop	T _j = 25 °C	I _F = 40A			0.77	V	
		T _j = 125 °C	I _F = 40A		0.67	0.71	

1. Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 0.42 \times I_{F(AV)} + 0.007 \times I_{F}^{2}_{(RMS)}$

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^{2.} Refer to Figure 12

 $[\]frac{dPtot}{dTj} < \frac{1}{Rth(j-a)} \,$ condition to avoid thermal runaway for a diode on its own heatsink

Figure 2. Conduction losses versus average current

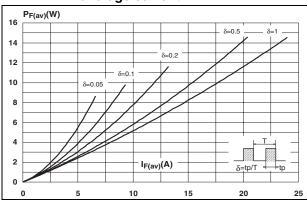


Figure 3. Average forward current versus ambient temperature ($\delta = 0.5$)

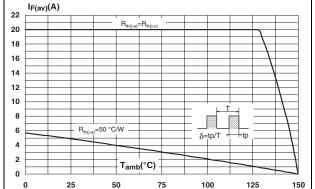


Figure 4. Normalized avalanche power derating versus pulse duration

Figure 5. Normalized avalanche power derating versus junction temperature

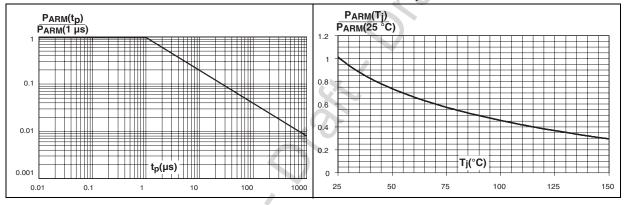


Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 7. Relative variation of thermal impedance junction to case versus pulse duration

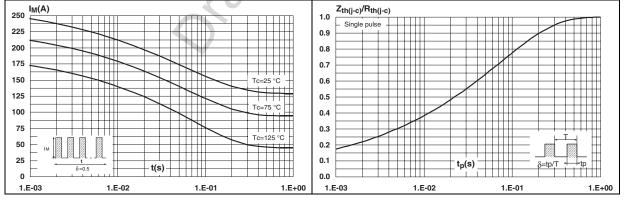


Figure 8. Reverse leakage current versus reverse voltage applied (typical values)

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Figure 9. Junction capacitance versus reverse voltage applied (typical values)

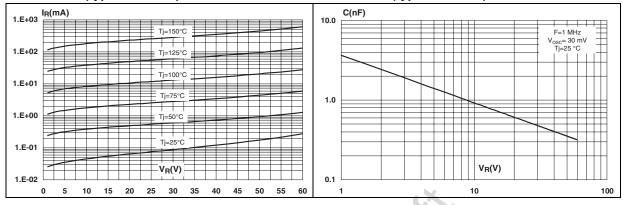


Figure 10. Forward voltage drop versus forward current

Figure 11. Thermal resistance junction to ambient versus copper surface under tab (STPS41L60CG only)

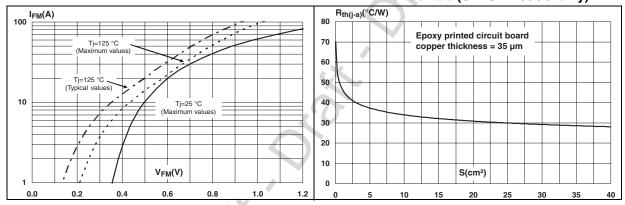
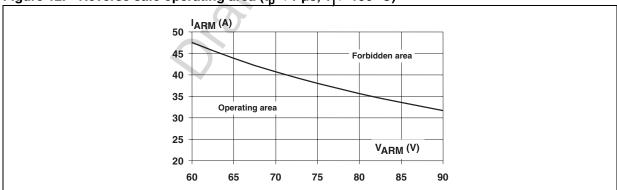


Figure 12. Reverse safe operating area ($t_p < 1 \mu s$, $T_i > 150 °C$)



Company Internal

2 Package information

Document CD00002861 STPS41L60C

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Figure 13. Package dimensions I²PAK

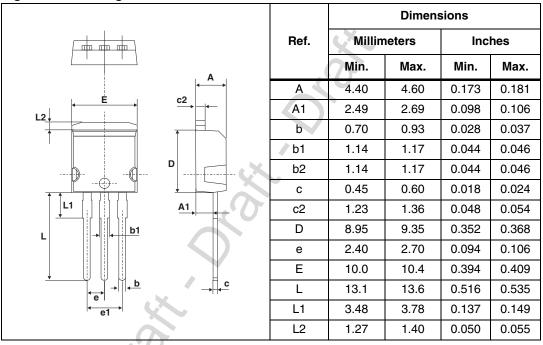




Figure 14. Package dimensions D²PAK

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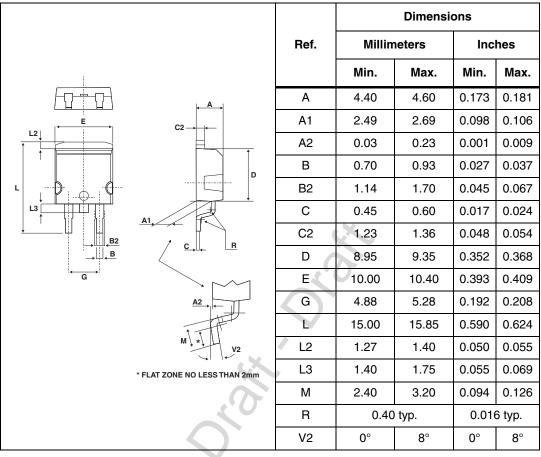
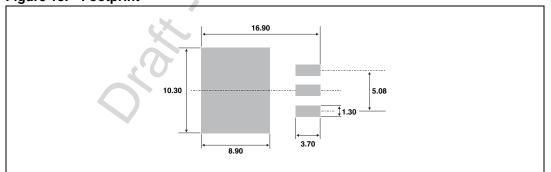
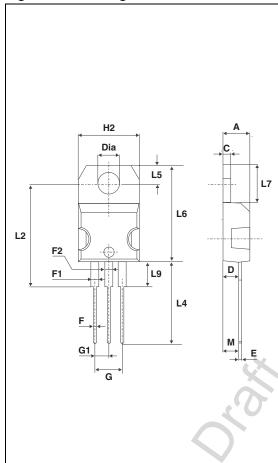


Figure 15. **Footprint**



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Package dimensions TO-220AB Figure 16.



	Dimensions				
Ref.	Millimeters		Inc	hes	
	Min.	Max.	Min.	Max.	
Α	4.40	4.60	0.173	0.181	
С	1.23	1.32	0.048	0.051	
D	2.40	2.72	0.094	0.107	
E	0.49	0.70	0.019	0.027	
F	0.61	0.88	0.024	0.034	
F1	1.14	1.70	0.044	0.066	
F2	1.14	1.70	0.044	0.066	
G	4.95	5.15	0.194	0.202	
G1	2.40	2.70	0.094	0.106	
H2	10	10.40	0.393	0.409	
L2	16.4	typ.	0.64	ō typ.	
L4	13	14	0.511	0.551	
L5	2.65	2.95	0.104	0.116	
L6	15.25	15.75	0.600	0.620	
L7	6.20	6.60	0.244	0.259	
L9	3.50	3.93	0.137	0.154	
М	2.6	typ.	0.102	2 typ.	
Diam.	3.75	3.85	0.147	0.151	

Ordering information 3

Table 5. **Ordering information**

6.1

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS41L60CG	STPS41L60CG	D ² PAK	1.48 g	50	Tube
STPS41L60CG-TR	STPS41L60CG	D ² PAK	1.48 g	1000	Tape and reel
STPS41L60CT	STPS41L60CT	TO-220AB	2.20 g	50	Tube
STPS41L60CR	STPS41L60CR	I ² PAK	1.49 g	50	Tube

Revision history 4

Table 6. **Document revision history**

Date	Revision	Changes
July 2003	3A	Previous issue
10-Jan-2007	4	Reformated to current standards. Added ECOPACK statement Removed I _{RRM} and dV/dT from the Absolute ratings table on page 1. Updated reverse leakage current values in Table 3 and Figure 7.
28-May-2007	5	Updated figures 1, 2, and 5 to 10.
15-Jul-2011	6	Added electrical diagram on first page. Added parameters V_{ARM} and V_{ASM} to <i>Table 2</i> . Added <i>Figure 12</i> .



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